

## SPECIFICATIONS

CUSTOMER	:	PTC
SAMPLE CODE	:	SH240320T-063-L04Q
MASS PRODUCTION CODE	:	PH240320T-063-L04Q
SAMPLE VERSION	:	02
SPECIFICATIONS EDITION	:	006
DRAWING NO. (Ver.)	:	LMD-PH240320T-063-L04Q (Ver:003)
PACKAGING NO. (Ver.)	:	PKG-PH240320T-063-L04Q (Ver:00&)

**Customer Approved**

**Date:**

Approved	Checked	Designer
廖志豪 Rex Liao	廖志豪 Rex Liao	張慶源 Yuan Chang

Preliminary specification for design input  
Specification for sample approval



## POWERTIP TECH. CORP.

### Headquarters:

No.8, 6<sup>th</sup> Road, Taichung Industrial Park,  
Taichung, Taiwan  
台中市 407 工業區六路 8 號

TEL: 886-4-2355-8168  
FAX: 886-4-2355-8166

E-mail: [sales@powertip.com.tw](mailto:sales@powertip.com.tw)  
[Http://www.powertip.com.tw](http://www.powertip.com.tw)

## History of Version

[illegible]

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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): ILITEK: ILI9341

## 1. SPECIFICATIONS

### 1.1 Features

#### Main LCD panel

Item	Standard Value
Display Type	240(R、G、B) * 320 Dots
LCD Type	Normally white , Transmissive type
Screen size(inch)	2.8 inch
Viewing Direction	12 O'clock
Color configuration	RGB-Strip
Backlight	LED Backlight
Interface	16-bit 80-system I/F
Other(controller/driver IC)	ILITEK: ILI9341
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website : <a href="http://www.powertip.com.tw/news.php?area_id_view=1085560481/">http://www.powertip.com.tw/news.php?area_id_view=1085560481/</a>

### 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	50.0(W) * 69.2 (L) * 4.25 max (H)	mm

#### LCD panel

Item	Standard Value	Unit
Active Area	43.2 (W) * 57.6 (L)	mm

### 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VCC	-	-0.3	+4.6	V
	VGH ~ VGL	-	-0.3	+32	V
Input Voltage	VIN	-	-0.3	VCC+0.3	V
Operating Temperature	T <sub>OP</sub>	-	-20	+70	°C
Storage Temperature	T <sub>ST</sub>	-	-30	+80	°C
Storage Humidity	H <sub>D</sub>	Ta 40 °C	20	90	%RH

### 1.4 DC Electrical Characteristics

#### Module

GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage1	VCC	-	-	2.8	-	V
Input High Voltage	V <sub>IH</sub>	-	0.7 VCC	-	VCC	V
Input Low Voltage	V <sub>IL</sub>	-	GND	-	0.3 VCC	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> =-0.1mA	0.8*VDD	-	VDD	V
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> =0.1mA	GND	-	0.2*VDD	V
Supply Current	ICC	VCC = 2.8V Pattern=full display *1	-	9	12	mA

Note1:Maximum current display

## 1.5 Optical Characteristics

### TFT LCD Module

VCC = 2.8V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	-
Response time		Tr+ Tf	Ta = 25°C θX, θY = 0°	-	31	47	ms	Note2
Viewing angle	Top	θY+	-	-	60	-	Deg.	Note4
	Bottom	θY-		-	60	-		
	Left	θX-		-	60	-		
	Right	θX+		-	60	-		
Contrast ratio		CR	Ta = 25°C θX , θY = 0°	200	500	600	-	Note3
Color of CIE Coordinate ( With B/L&T/P )	White	X	-	0.26	0.31	0.36	-	Note1
		Y		0.28	0.33	0.38		
	Red	X		0.58	0.63	0.68		
		Y		0.3	0.35	0.4		
	Green	X		0.29	0.34	0.39		
		Y		0.56	0.61	0.66		
	Blue	X		0.09	0.14	0.19		
		Y		0.02	0.07	0.12		
Average Brightness Pattern=white display (With B/L&T/P) *1		IV	IF=80 mA	180	200	-	cd/m <sup>2</sup>	
Uniformity (With B/L&T/P)*2		B	IF=80 mA	70	-	-	%	

Note 1:

\*1 :  $B = B(\min) / B(\max) * 100\%$

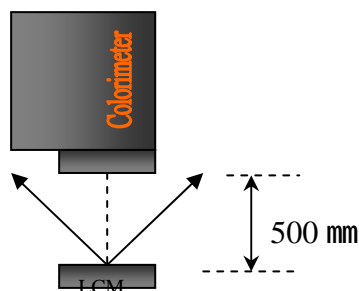
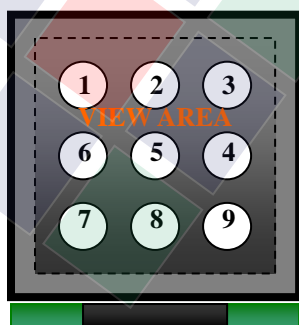
\*2 : Measurement Condition for Optical Characteristics:

a : Environment: 25 ±5 / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 ± 50 mm , (θ= 0°)

c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.

d : The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%



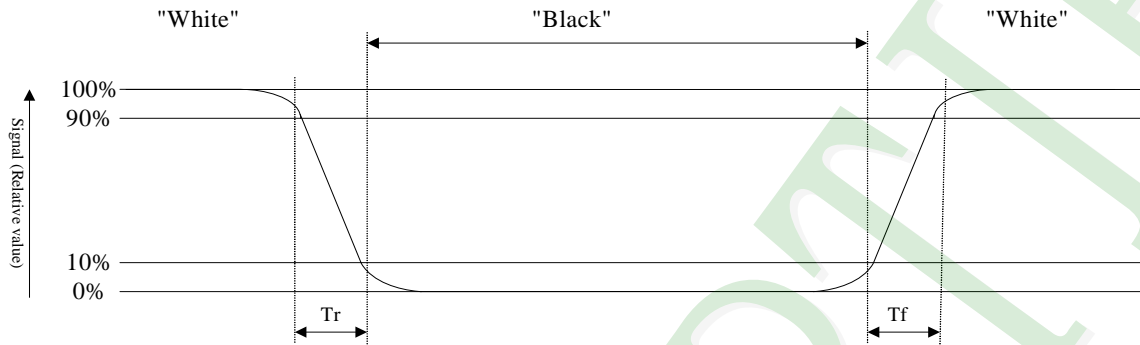
Colorimeter=BM-7 fast

To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

**Note2: Definition of response time:**

The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



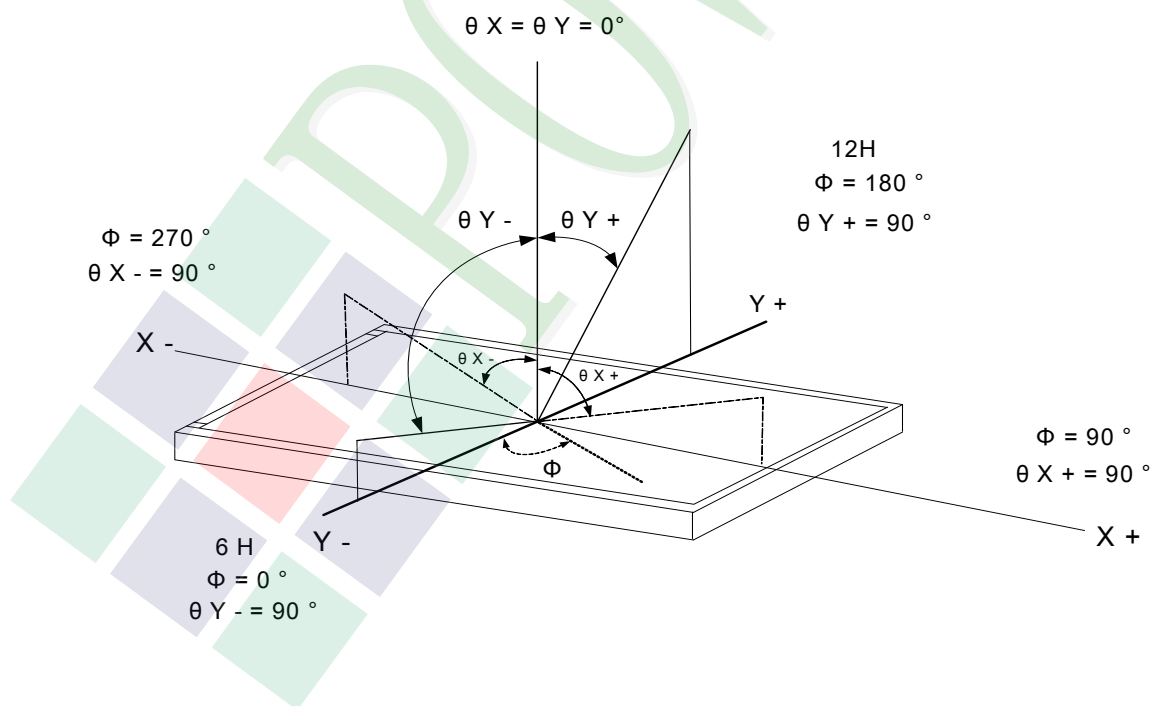
**Note3: Definition of contrast ratio:**

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector output when LCD is at "Black" state}}$$

**Note4: Definition of viewing angle:**

Refer to figure as below:



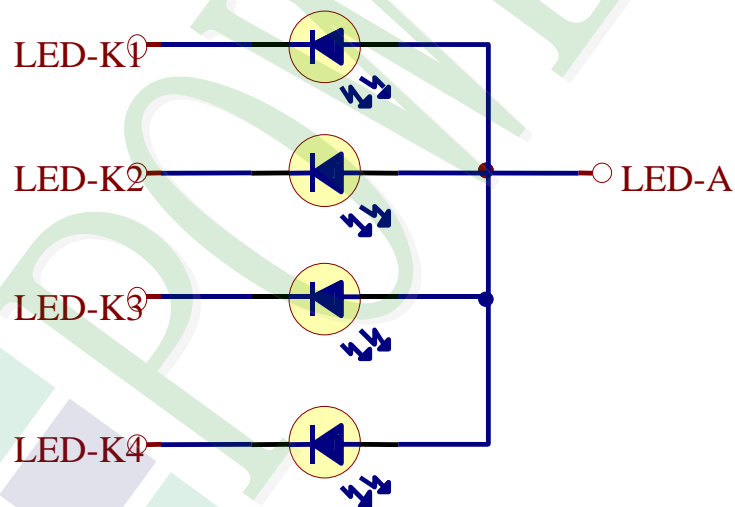
## 1.6 Backlight Characteristics

### Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Power Dissipation	PD	Ta =25	-	0.288	W

### Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF= 80 mA	2.8	-	3.6	V
Average Brightness (without LCD)	IV		5000	5500	-	cd/m <sup>2</sup>
CIE Color Coordinate (Without LCD)	X		0.26	0.28	0.33	-
	Y		0.26	0.28	0.33	
Color	White					



Item	Conditions	Description
MTBF (Life Time)	Ta =25 IF= 80 mA	20000 hrs



## 1.7 Touch Panel Characteristics

### 1.7.1 General Standard Specification

Item	Specification	
Input Method	Finger of stylus pen	
ITO Glass	T=0.7mm,400Ω/□ ±100Ω , Non-Antiglare	
ITO Film	T=0.18mm,400Ω/□ ±100Ω Clear Type	
Operating Temperature Range	-20 ~70 ,20~85%RH(Except for dew gathering).	
Storage Temperature Range	-30 ~85 ,10~90%RH (Except for dew gathering).	
Surface Hardness	3H-prpressure 500gf,45deg.	
Hitting Durability	1,000,000times min.(Tip R 8 mm&R0.8mm).	
Pen Sliding Durability	100,000 times min(Tip R0.8mm).	
Insulation Impedance	DC25V 1min,20MΩ↑.	
Light Transparency	80%min	
Linearity	172g ±1.5%(±1.5%After environmental and life test)	
Linearity Force	80gf less input with stylus pen (R0.8mm)	
Activation Force	50gf(Typical 20gf)less individual point on with stylus pen R0.8mm	
Bouncing	<10ms	
Impact Resistance	No damage when ϕ9mm steel ball is dropped on the surface from 30 cm height at 1 time.	
Flexible pattern Heat Seal Peeling Strength	500gf/cm (peeling upward by 90deg)	
Flexible pattern Bending Resistance	Bending 3 times by bending radius R1.0 mm The requirements in4-2shall be satisfied	
Flexible Pattern Insert/Pull Out Resistance	5times at least .The requirements in 4-2shall be satisfied.	
Vibration Resistance	Not in operation :The requirements in 3 to 4 shall be satisfied after sweep vibration of 2G15~55Hz(1min) is given for 30 min ,each in the directions of X,Y,Z.	
Package Drop	No damage to the product.(1 corner edge,2ridges,4 surfaces ,drop from 50 cm height).	
Static load resistance	After 4.5Kg load for 1 min is Applied to the center area (25C m <sup>2</sup> )of the Touch panel ,the requirements in 3 and 4,shall be satisfied.	

### 1.7.2 Touch Panel Optical & Electrical Characteristics

Test by light measure device and the result should be 80%min.

(A) Insulation Resistance.

20 MΩ or more (DC 25 1min)

(B) Resistance Between Terminals.

Direction X (Glass side): 100Ω~ 500Ω

Direction Y (Film side): 350Ω~ 850Ω

(C) Linearity.

± 1.5% Measuring method, Linearity(%)=  $\Delta V / (EV - SV) \times 100$

± 1.5%(after environmental and life test)

$\Delta V$ : The difference between the ideal voltage and measured voltage on the each measuring line.

SV: Voltage of starting Points

EV: Voltage of Ending Points

(D) Operating Voltage.

5V DC.

Max Voltage : 7V DC.

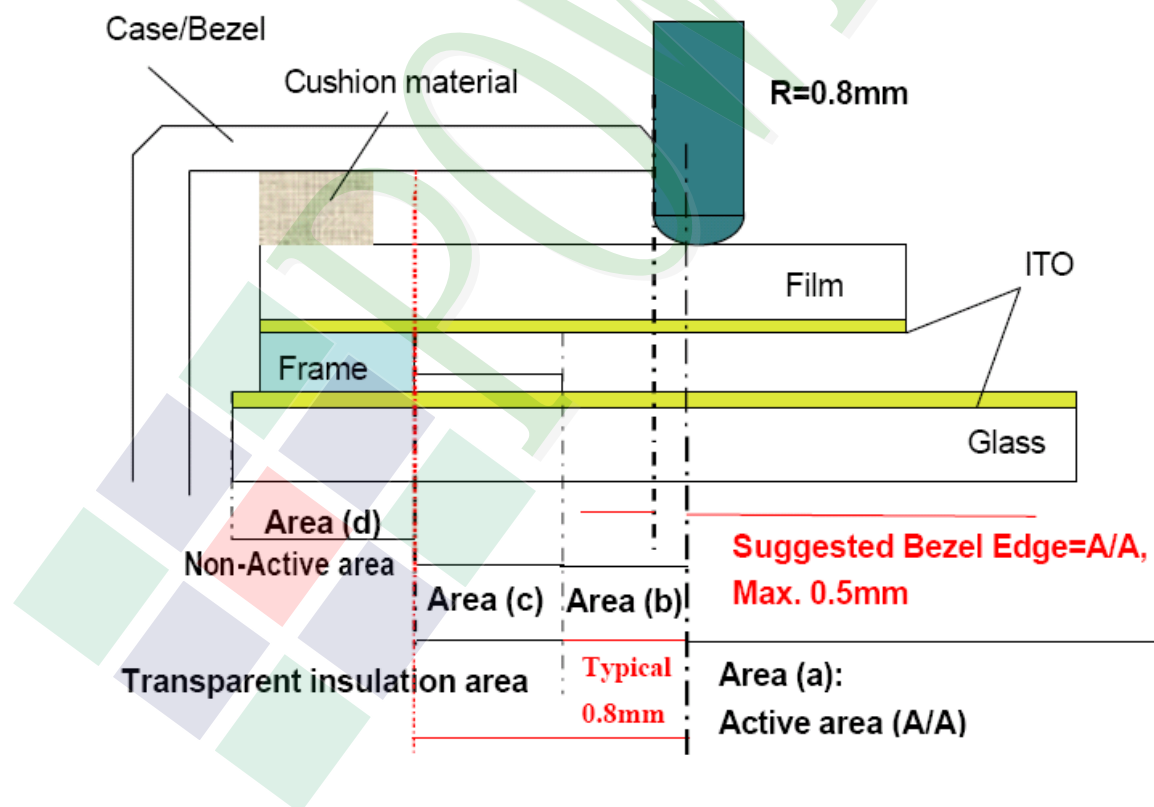
(E) Bouncing

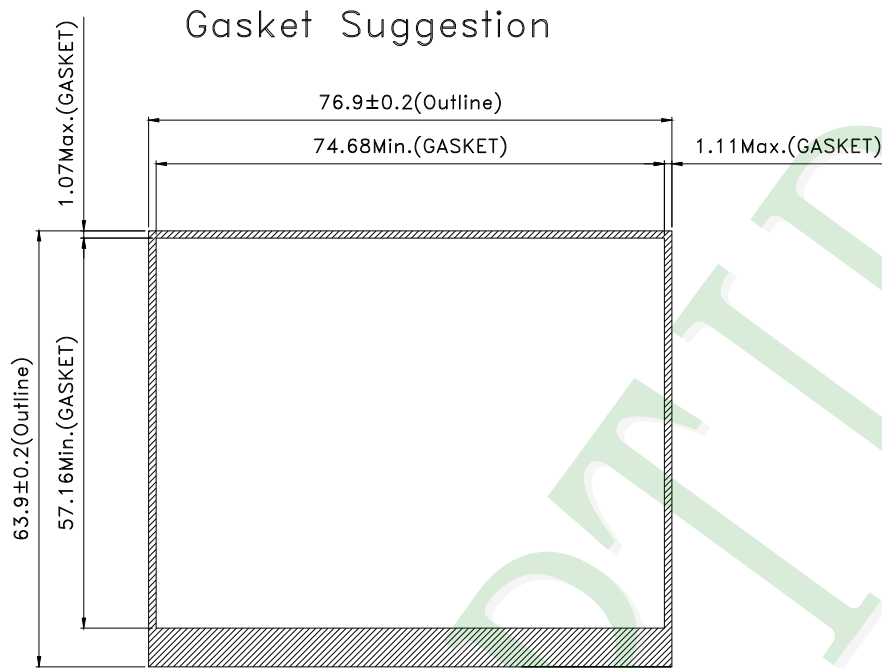
<10ms

Tip R 3.75mm, hardness 10°~20° ,silicon rubber ,500gf operation : 40 mm/sec.

### 1.7.3 Touch Panel Design/Handling Guide

- (1) Keep the gap, for example 0.3 to 0.7mm, between bezel edge and T/P surface.  
The reason is to avoid the bezel edge from contacting T/P surface that may cause “short” with bottom layer
- (2) Insertion a cushion material is recommended.
- (3) The cushion material should be limited on the busbar insulation paste area. If it is over the transparent insulation paste area, a “short” may be occurred.
- (4) Do not to use an adhesive tape to bond it on the front of T/P and hang it to the housing bezel.
- (5) Never expand the T/P top layer (PET Film) like a balloon by internal air pressure. The life of the T/P will extremely decreasing.
- (6) Top layer, PET, dimension is changing base on environment temperature and humidity. Please avoid a stress from housing bezel to top layer, because it may cause “waving”.
- (7) The input to the Touch Panel sometimes distorts touch panel itself.
- (8) To use the stylus pen or fingernail sliding at the edge of the housing is prohibited. It would cause the cracking of the ITO coating and damage the touch panel. It also request not to press this area while assembling
- (9) Purpose: In order to prevent accidental use and performance deterioration, please keep the following precautions.





In order to prevent unusual performance degradation and malfunction of a touch panel, please carry out the set case designing and a touch panel assembling method after surely considering the definition of each area illustrated in above figure.

#### Area(a) : Active area

The active area is guaranteed the position data detectable precision, operation force and other operations. it is strongly recommended to place the operation button or menu keys within the active area. Due to structure, the active area is less durable at the edge or close to the edge.

#### Area(b) : Operation non-guaranteed area

This area does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared with the active area (area-(a) as guaranteed area) and its operation force requires about double. About 0.5 mm outside from a boundary of the active area corresponds to this area.

#### Area(c) : Pressing prohibition area

The area which forbids pressing, because an excessive load is applied to a transparent electrode (ITO) and a serious damage is given to a touch panel function by pressing.

#### Area(d) : Non-Active area

The area does not activate even if pressed.

### 1.7.3 Touch Panel Design/Handing Guide

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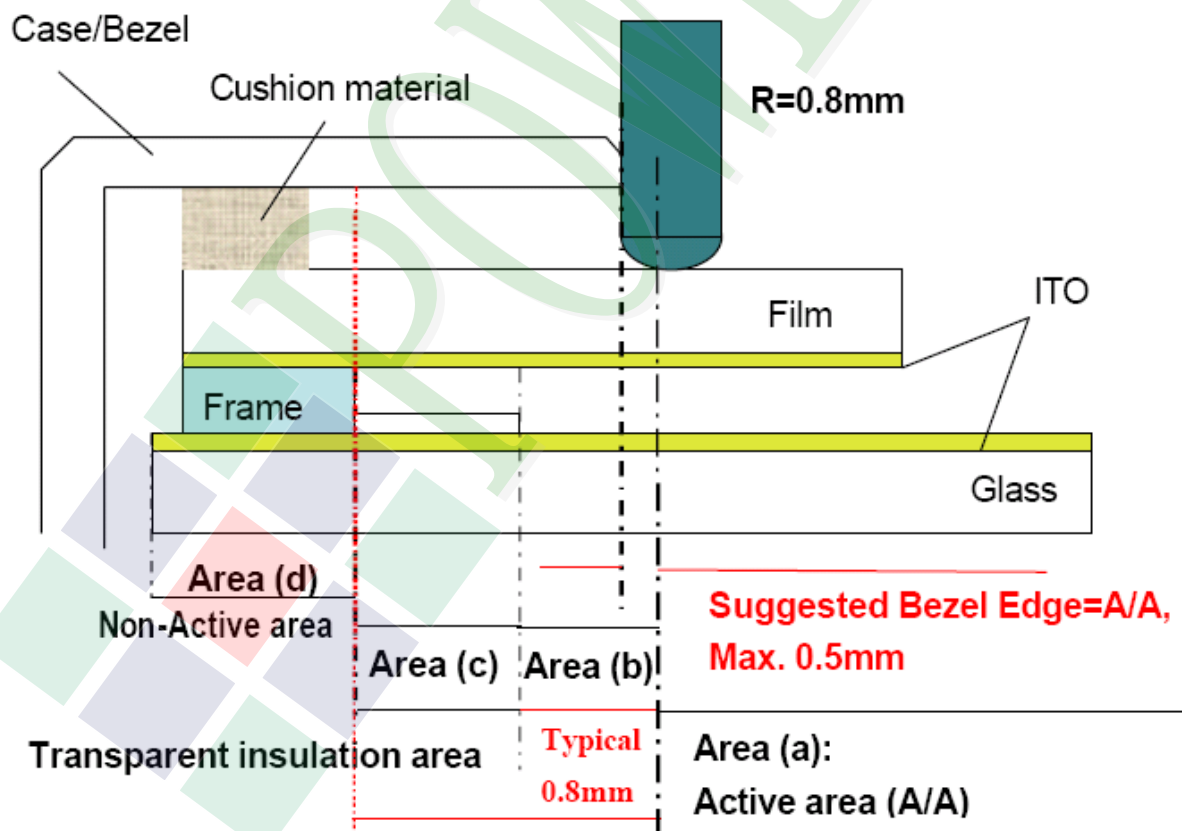
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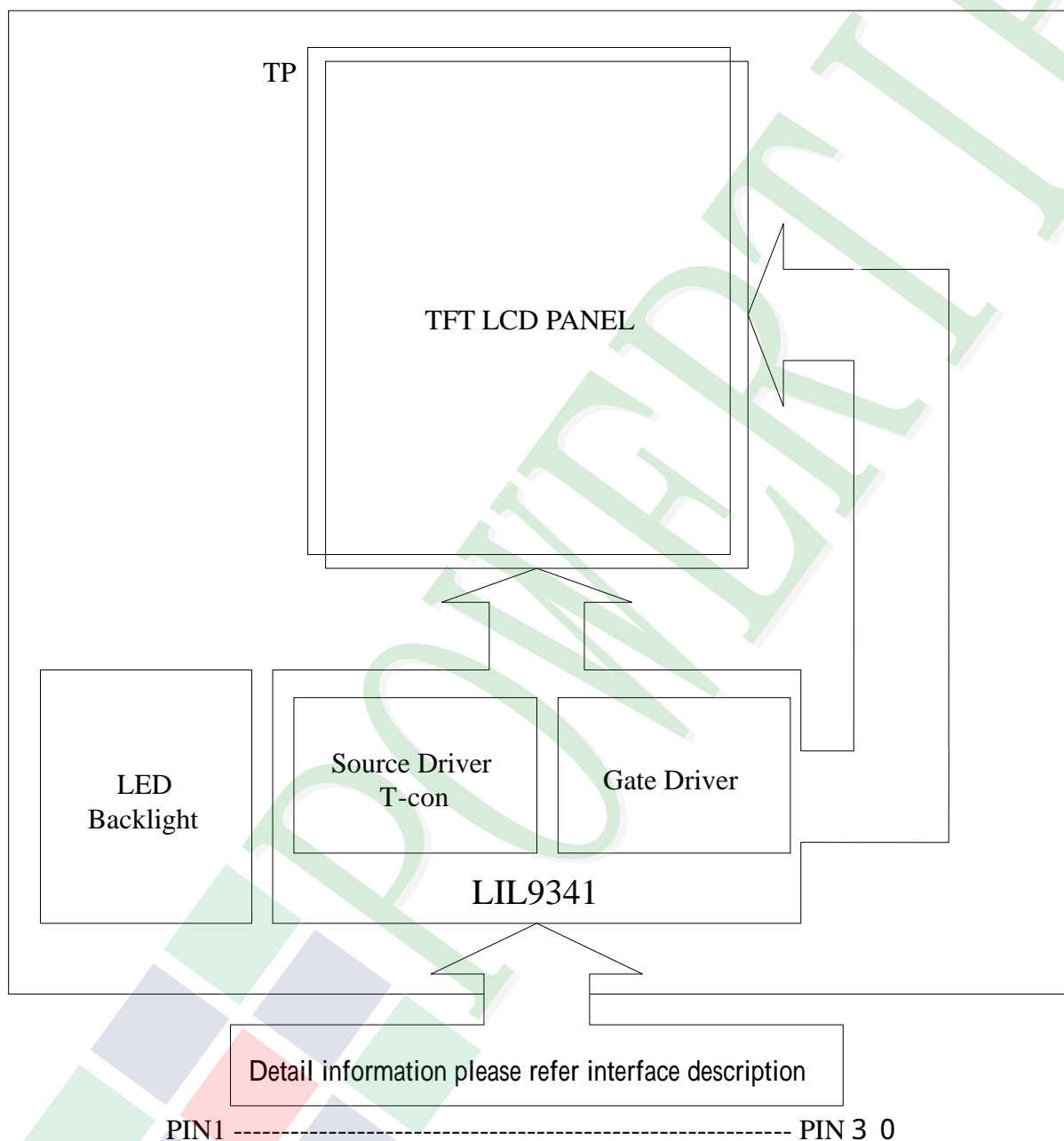


## 2.1 Counter Drawing

### 2.1.1 LCM Mechanical Diagram

\* See Appendix

### 2.1.2 Block Diagram



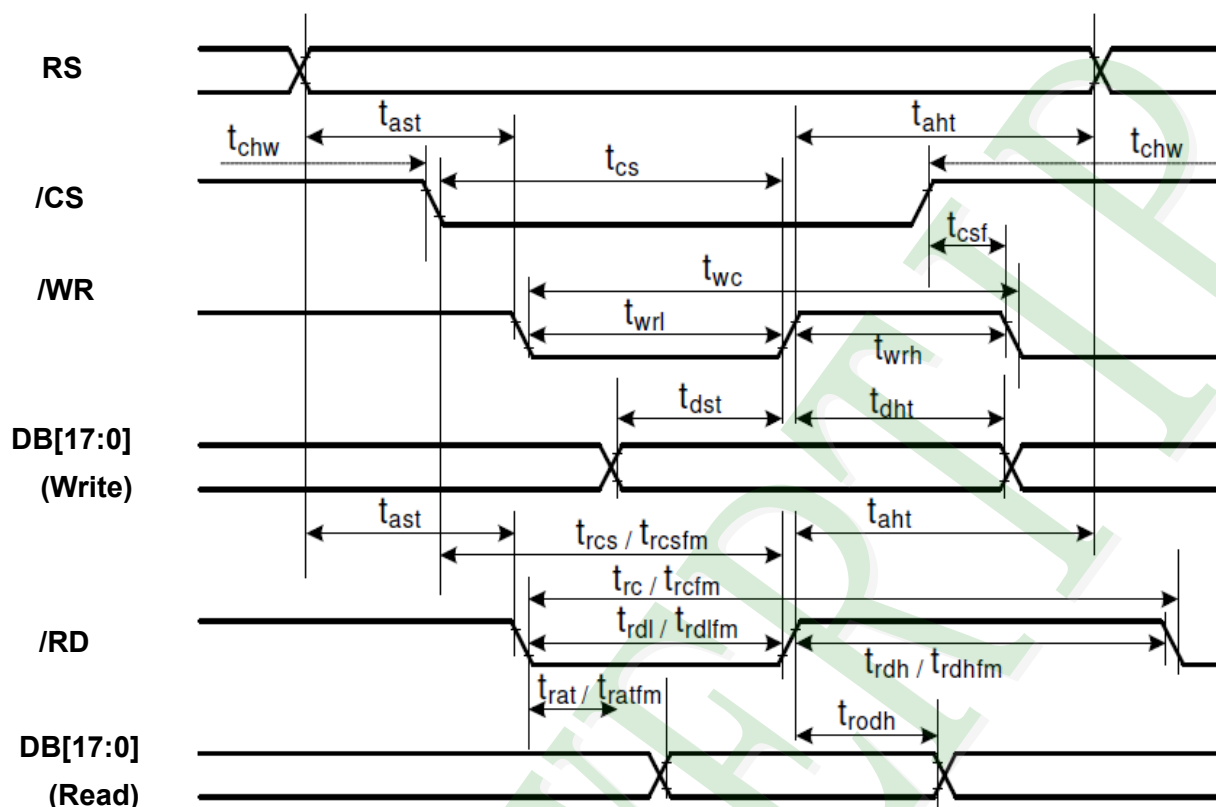
## 2.2 Interface Pin Description

Pin No.	Symbol	Function
1	LEDK1-4	Power supply for LED Backlight Cathode input
2	LEDA	Power supply for LED Backlight Anode input
3	GND	Signal ground.(0V)
4	RESET	Reset input pin for TFT LCD. When RESET is "L", initialization is executed.
5	DB17	Bi-directional data bus
6	DB16	
7	DB15	
8	DB14	
9	DB13	
10	DB12	
11	DB11	
12	DB10	
13	DB8	
14	DB7	
15	DB6	
16	DB5	
17	DB4	
18	DB3	
19	DB2	
20	DB1	
21	RD	Read signal input , active at Low.
22	WR/SCL	Write signal input , active at Low.
23	RS	When RS = 0: Command.    When RS = 1: Display data.
24	CS	Chip select signal , Active at "L"
25	XR/X+	Right side of touch panel.



Pin No.	Symbol	Function
26	YD/Y-	Bottom side of touch panel.
27	XL/X-	Left side of touch panel.
28	YU/Y+	Up side of touch panel.
29	GND	Signal ground.(0V)
30	2.8 /VCC	Power supply for the internal logic circuit.

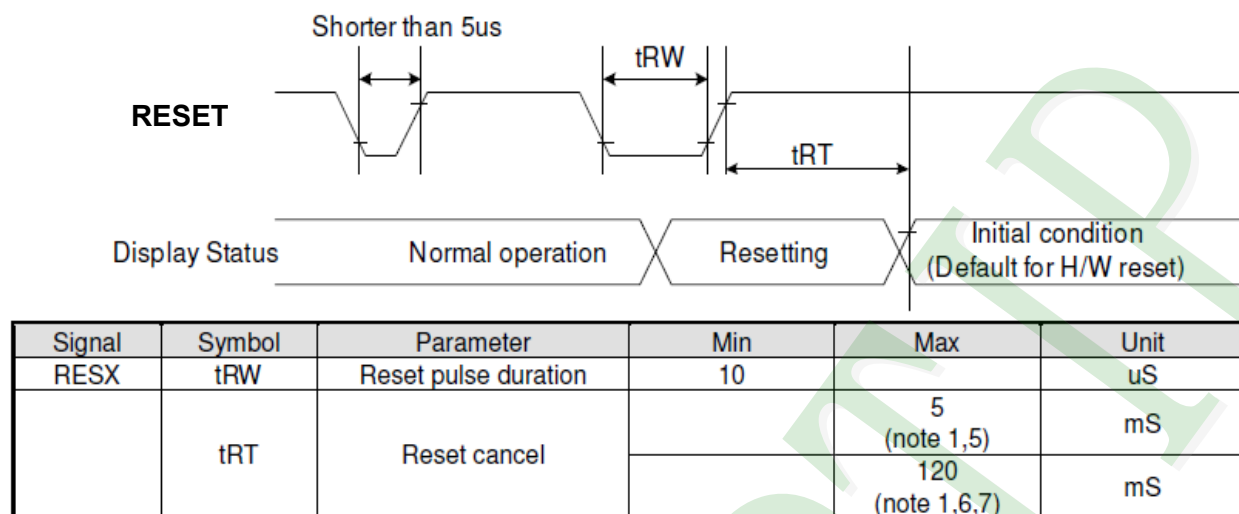
## 2.3 Timing Characteristics



Signal	Symbol	Parameter	min	max	Unit	Description
RS	$t_{ast}$	Address setup time	0	-	ns	
	$t_{aht}$	Address hold time (Write/Read)	0	-	ns	
/CS	$t_{chw}$	CSX "H" pulse width	0	-	ns	
	$t_{cs}$	Chip Select setup time (Write)	15	-	ns	
	$t_{rcs}$	Chip Select setup time (Read ID)	45	-	ns	
	$t_{rcsfm}$	Chip Select setup time (Read FM)	355	-	ns	
	$t_{csf}$	Chip Select Wait time (Write/Read)	10	-	ns	
/WR	$t_{wc}$	Write cycle	66	-	ns	
	$t_{wrh}$	Write Control pulse H duration	15	-	ns	
	$t_{wrl}$	Write Control pulse L duration	15	-	ns	
/RD(FM)	$t_{rcfm}$	Read Cycle (FM)	450	-	ns	
	$t_{rdhfm}$	Read Control H duration (FM)	90	-	ns	
	$t_{rdlfm}$	Read Control L duration (FM)	355	-	ns	
/RD(ID)	$t_{rc}$	Read cycle (ID)	160	-	ns	
	$t_{rdh}$	Read Control pulse H duration	90	-	ns	
	$t_{rdl}$	Read Control pulse L duration	45	-	ns	
DB[17:0] DB[17:0] DB[8:0] DB[7:0]	$t_{dst}$	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	$t_{dht}$	Write data hold time	10	-	ns	
	$t_{rat}$	Read access time	-	40	ns	
	$t_{ratfm}$	Read access time	-	340	ns	
	$t_{rod}$	Read output disable time	20	80	ns	

Note:  $T_a = -30$  to  $70\text{ }^{\circ}\text{C}$ ,  $V_{CC}=1.65\text{V}$  to  $3.3\text{V}$ ,  $V_{CI}=2.5\text{V}$  to  $3.3\text{V}$ ,  $GND=0\text{V}$

## Reset Timing



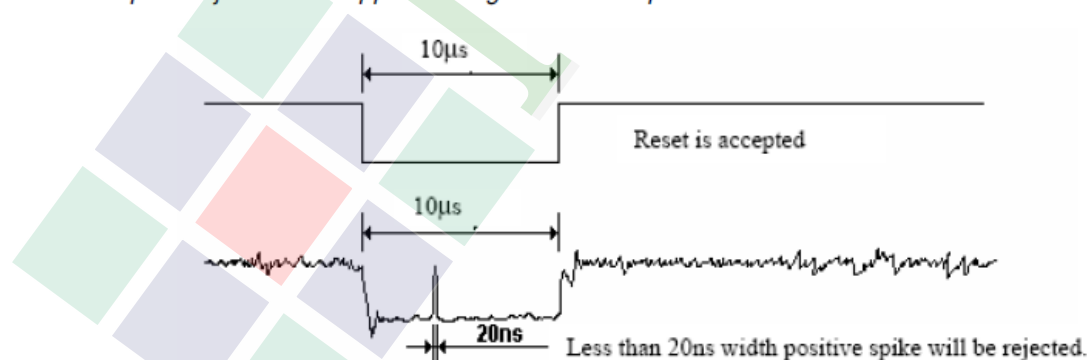
**Note 1:** The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

**Note 2:** Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

**Note 3:** During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.

**Note 4:** Spike Rejection also applies during a valid reset pulse as shown below:



**Note 5:** When Reset applied during Sleep In Mode.

**Note 6:** When Reset applied during Sleep Out Mode.

**Note 7:** It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

## 2.4 Reference Initial code

```
MOV    ADDRH,#00H
MOV    ADDRL,#CBH
CALL   WRITE_COMMAND
MOV    ADDRL,#39H
CALL   WRITE_DATA
MOV    ADDRL,#2CH
CALL   WRITE_DATA
MOV    ADDRL,#00H
CALL   WRITE_DATA
MOV    ADDRL,#34H
CALL   WRITE_DATA
MOV    ADDRL,#02H
CALL   WRITE_DATA
```

```
MOV    ADDRL,#CFH
CALL   WRITE_COMMAND
MOV    ADDRL,#00H
CALL   WRITE_DATA
MOV    ADDRL,#C1H
CALL   WRITE_DATA
MOV    ADDRL,#30H
CALL   WRITE_DATA
```

```
MOV    ADDRL,#E8H
CALL   WRITE_COMMAND
MOV    ADDRL,#85H
CALL   WRITE_DATA
MOV    ADDRL,#00H
CALL   WRITE_DATA
MOV    ADDRL,#78H
CALL   WRITE_DATA
MOV    ADDRH,#00H
MOV    ADDRL,#EAH
CALL   WRITE_COMMAND
MOV    ADDRL,#00H
CALL   WRITE_DATA
MOV    ADDRL,#00H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#EDH
CALL   WRITE_COMMAND
MOV    ADDRL,#64H
CALL   WRITE_DATA
MOV    ADDRL,#03H
CALL   WRITE_DATA
MOV    ADDRL,#12H
CALL   WRITE_DATA
MOV    ADDRL,#81H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#F7H
CALL   WRITE_COMMAND
MOV    ADDRL,#20H
CALL   WRITE_DATA
```



```
MOV    ADDRH,#00H
MOV    ADDRL,#C0H
CALL   WRITE_COMMAND
MOV    ADDRL,#23H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#C1H
CALL   WRITE_COMMAND
MOV    ADDRL,#10H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#C5H
CALL   WRITE_COMMAND
MOV    ADDRL,#2BH
CALL   WRITE_DATA
MOV    ADDRL,#2BH
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#C7H
CALL   WRITE_COMMAND
MOV    ADDRL,#C0H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#36H
CALL   WRITE_COMMAND
MOV    ADDRL,#40H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#B1H
CALL   WRITE_COMMAND
MOV    ADDRL,#00H
CALL   WRITE_DATA
MOV    ADDRL,#1BH
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#B6H
CALL   WRITE_COMMAND
MOV    ADDRL,#0AH
CALL   WRITE_DATA
MOV    ADDRL,#02H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#F2H
CALL   WRITE_COMMAND
MOV    ADDRL,#00H
CALL   WRITE_DATA
```

```
MOV    ADDRH,#00H
MOV    ADDRL,#26H
CALL   WRITE_COMMAND
MOV    ADDRL,#01H
```

```
CALL    WRITE_DATA

MOV     ADDRH,#00H
MOV     ADDRL,#3AH
CALL    WRITE_COMMAND
MOV     ADDRL,#55H
CALL    WRITE_DATA

MOV     ADDRH,#00H
MOV     ADDRL,#21H
CALL    WRITE_COMMAND

MOV     ADDRH,#00H
MOV     ADDRL,#E0H
CALL    WRITE_COMMAND
MOV     ADDRL,#0FH
CALL    WRITE_DATA
MOV     ADDRL,#31H
CALL    WRITE_DATA
MOV     ADDRL,#2BH
CALL    WRITE_DATA
MOV     ADDRL,#0CH
CALL    WRITE_DATA
MOV     ADDRL,#0EH
CALL    WRITE_DATA
MOV     ADDRL,#08H
CALL    WRITE_DATA
MOV     ADDRL,#4EH
CALL    WRITE_DATA
MOV     ADDRL,#F1H
CALL    WRITE_DATA
MOV     ADDRL,#37H
CALL    WRITE_DATA
MOV     ADDRL,#07H
CALL    WRITE_DATA
MOV     ADDRL,#10H
CALL    WRITE_DATA
MOV     ADDRL,#03H
CALL    WRITE_DATA
MOV     ADDRL,#0EH
CALL    WRITE_DATA
MOV     ADDRL,#09H
CALL    WRITE_DATA
MOV     ADDRL,#00H
CALL    WRITE_DATA

MOV     ADDRH,#00H
MOV     ADDRL,#E1H
CALL    WRITE_COMMAND
MOV     ADDRL,#00H
CALL    WRITE_DATA
MOV     ADDRL,#0EH
CALL    WRITE_DATA
MOV     ADDRL,#14H
CALL    WRITE_DATA
MOV     ADDRL,#03H
CALL    WRITE_DATA
MOV     ADDRL,#11H
```



```
CALL    WRITE_DATA
MOV     ADDR_L,#07H
CALL    WRITE_DATA
MOV     ADDR_L,#31H
CALL    WRITE_DATA
MOV     ADDR_L,#C1H
CALL    WRITE_DATA
MOV     ADDR_L,#48H
CALL    WRITE_DATA
MOV     ADDR_L,#08H
CALL    WRITE_DATA
MOV     ADDR_L,#0FH
CALL    WRITE_DATA
MOV     ADDR_L,#0CH
CALL    WRITE_DATA
MOV     ADDR_L,#31H
CALL    WRITE_DATA
MOV     ADDR_L,#36H
CALL    WRITE_DATA
MOV     ADDR_L,#0FH
CALL    WRITE_DATA

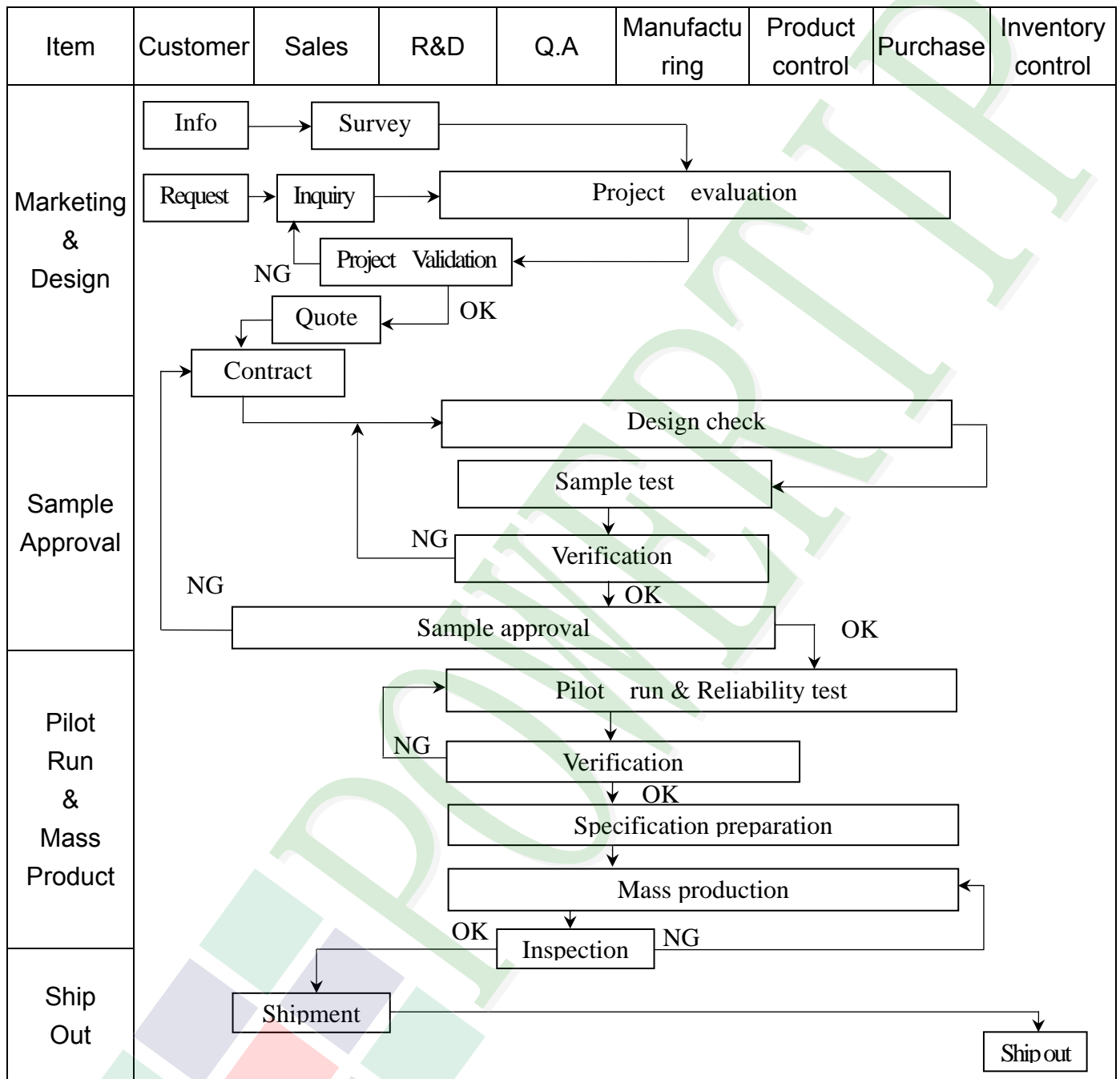
MOV     ADDR_H,#00H
MOV     ADDR_L,#11H
CALL    WRITE_COMMAND

CALL    DELAY
CALL    DELAY
CALL    DELAY
CALL    DELAY

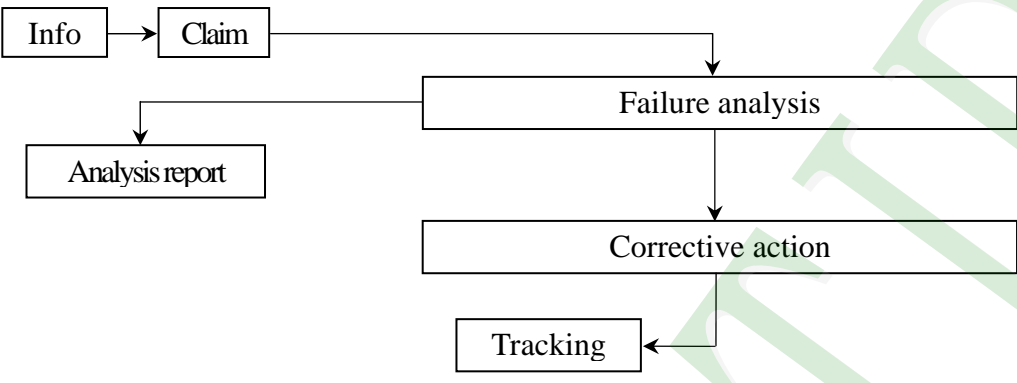
MOV     ADDR_H,#00H
MOV     ADDR_L,#29H
CALL    WRITE_COMMAND
```

### 3. QUALITY ASSURANCE SYSTEM

#### 3.1 Quality Assurance Flow Chart





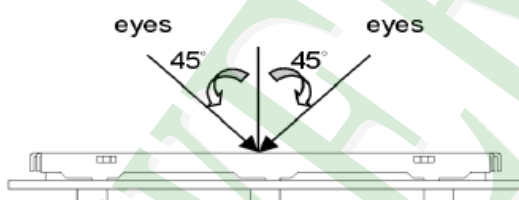
Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service	 <pre> graph TD     Info[Info] --&gt; Claim[Claim]     Claim --&gt; FA[Failure analysis]     FA --&gt; AR[Analysis report]     FA --&gt; CA[Corrective action]     CA --&gt; Tracking[Tracking]           </pre>							
Q.A Activity	1. ISO 9001 Maintenance Activities 3. Equipment calibration 5. Standardization Management				2. Process improvement proposal 4. Education And Training Activities			

## 3.2 Inspection Specification

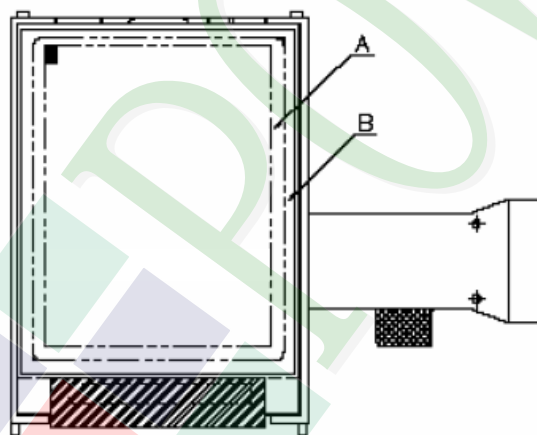
- ◆ **Scope** : The document shall be applied to TFT-LCD Module for less than 3.5" (Ver.B01).
- ◆ **Inspection Standard** : MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ◆ **Equipment** : Gauge 、 MIL-STD 、 Powertip Tester 、 Sample
- ◆ **Defect Level** : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ◆ **OUT Going Defect Level** : Sampling.
- ◆ **Standard of the product appearance test** :

### a. Manner of appearance test :

- (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



### (3). Definition of area.



*A* area : viewing area

*B* area : Outside of viewing area

### (4). Standard of inspection : (Unit : mm)

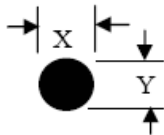
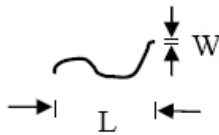
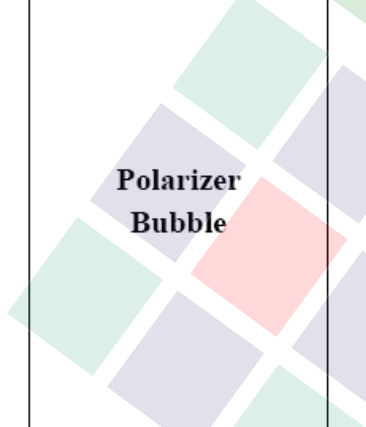
**◆ Specification For TFT-LCD Module Less Than 3.5" :**

(Ver.B01)

NO	Item	Criterion	Level												
01	Product condition	1. 1The part number is inconsistent with work order of production.	Major												
		1. 2 Mixed product types.	Major												
		1. 3 Assembled in inverse direction.	Major												
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major												
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major												
04	Electrical Testing	4. 1 Missing line character and icon.	Major												
		4. 2 No function or no display.	Major												
		4. 3 Display malfunction.	Major												
		4. 4 LCD viewing angle defect.	Major												
		4. 5 Current consumption exceeds product specifications.	Major												
05	<div>Dot defect</div> <div>(Bright dot 、 Dark dot)</div> <div>On -display</div>	<table><thead><tr><th colspan="2">Item</th><th>Acceptance (Q'ty)</th></tr></thead><tbody><tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≤ 2</td></tr><tr><td>Dark Dot</td><td>≤ 3</td></tr><tr><td>Joint Dot</td><td>≤ 2</td></tr><tr><td>Total</td><td>≤ 3</td></tr></tbody></table> <div>5. 1 Inspection pattern : full white , full black , Red , Green and blue screens.</div> <div>5. 2 It is defined as dot defect if defect area &gt;1/2 dot.</div> <div>5. 3 The distance between two dot defect ≥5 mm.</div>	Item		Acceptance (Q'ty)	Dot Defect	Bright Dot	≤ 2	Dark Dot	≤ 3	Joint Dot	≤ 2	Total	≤ 3	Minor
Item		Acceptance (Q'ty)													
Dot Defect	Bright Dot	≤ 2													
	Dark Dot	≤ 3													
	Joint Dot	≤ 2													
	Total	≤ 3													

**◆ Specification For TFT-LCD Module Less Than 3.5" :**

(Ver.B01)

NO	Item	Criterion	Level																																							
06	<p>Black or white dot、scratch、contamination</p> <p>Round type</p>  <p><math>\Phi=(x+y) / 2</math></p> <p>Line type</p> 	<p>6. 1 Round type ( Non-display or display ) :</p> <table><tr><th rowspan="2">Dimension (diameter : <math>\Phi</math>)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td><math>\Phi \leq 0.15</math></td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td><math>0.15 &lt; \Phi \leq 0.20</math></td><td>2</td></tr><tr><td><math>0.20 &lt; \Phi \leq 0.30</math></td><td>2</td></tr><tr><td><math>\Phi &gt; 0.30</math></td><td>0</td></tr><tr><td>Total</td><td>3</td><td></td></tr></table> <p>6. 2 Line type( Non-display or display ) :</p> <table><tr><th colspan="2">Dimension</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>Length (L)</th><th>Width (W)</th><th>A area</th><th>B area</th></tr><tr><td>---</td><td><math>W \leq 0.03</math></td><td>Ignore</td><td rowspan="3">Ignore</td></tr><tr><td><math>L \leq 5.0</math></td><td><math>0.03 &lt; W \leq 0.05</math></td><td>3</td></tr><tr><td>---</td><td><math>W &gt; 0.05</math></td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>3</td><td></td></tr></table>	Dimension (diameter : $\Phi$ )	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.15$	Ignore	Ignore	$0.15 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.30$	2	$\Phi > 0.30$	0	Total	3		Dimension		Acceptance (Q'ty)		Length (L)	Width (W)	A area	B area	---	$W \leq 0.03$	Ignore	Ignore	$L \leq 5.0$	$0.03 < W \leq 0.05$	3	---	$W > 0.05$	As round type	Total		3		Minor
Dimension (diameter : $\Phi$ )	Acceptance (Q'ty)																																									
	A area	B area																																								
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Total	3																																									
Dimension		Acceptance (Q'ty)																																								
Length (L)	Width (W)	A area	B area																																							
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$L \leq 5.0$	$0.03 < W \leq 0.05$	3																																								
---	$W > 0.05$	As round type																																								
Total		3																																								
07	<p>Polarizer Bubble</p> 	<table><tr><th rowspan="2">Dimension (diameter : <math>\Phi</math>)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td><math>\Phi \leq 0.20</math></td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td><math>0.20 &lt; \Phi \leq 0.50</math></td><td>3</td></tr><tr><td><math>\Phi &gt; 0.50</math></td><td>0</td></tr><tr><td>Total</td><td>3</td></tr></table>	Dimension (diameter : $\Phi$ )	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.20$	Ignore	Ignore	$0.20 < \Phi \leq 0.50$	3	$\Phi > 0.50$	0	Total	3	Minor																									
Dimension (diameter : $\Phi$ )	Acceptance (Q'ty)																																									
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Total	3																																									

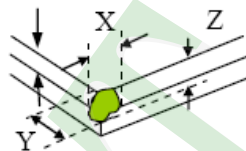
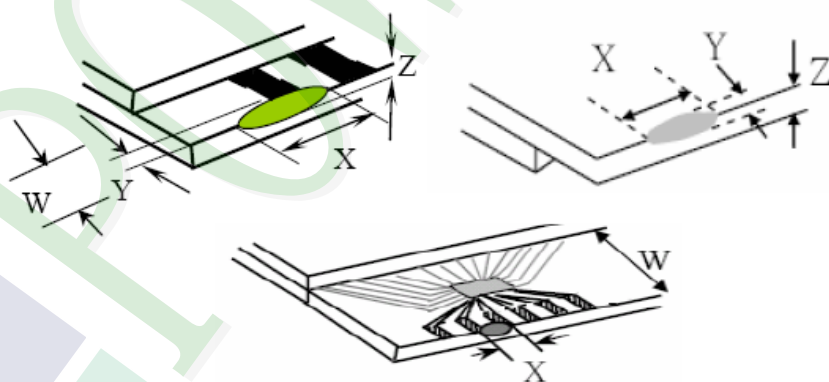
◆ Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level									
08	The crack of glass	<p><b>Symbols :</b></p> <div> <div> <p><b>X :</b> The length of crack</p> <p><b>Z :</b> The thickness of crack</p> <p><b>t :</b> The thickness of glass</p> </div> <div> <p><b>Y :</b> The width of crack.</p> <p><b>W :</b> terminal length</p> <p><b>a :</b> LCD side length</p> </div> </div> <hr/> <p>8.1 General glass chip :</p> <p>8.1.1 Chip on panel surface and crack between panels:</p> <div> </div> <table> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> <tr> <td><math>\leq a</math></td> <td>Crack can't enter viewing area</td> <td><math>\leq 1/2 t</math></td> </tr> <tr> <td><math>\leq a</math></td> <td>Crack can't exceed the half of SP width.</td> <td><math>1/2 t &lt; Z \leq 2 t</math></td> </tr> </table>	X	Y	Z	$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$	$\leq a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	Minor
		X	Y	Z								
$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$										
$\leq a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$										

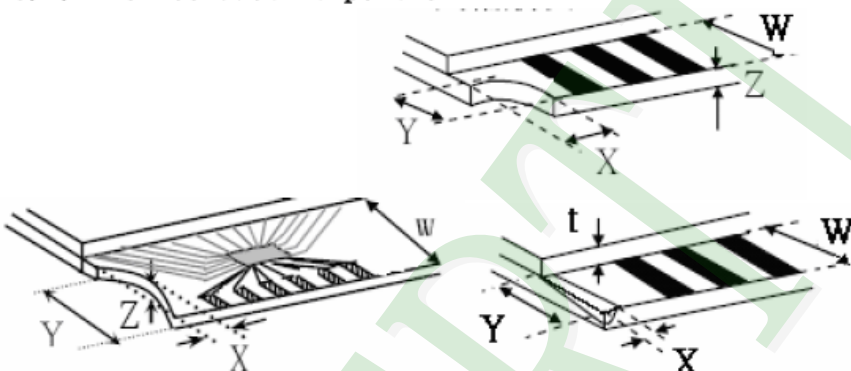
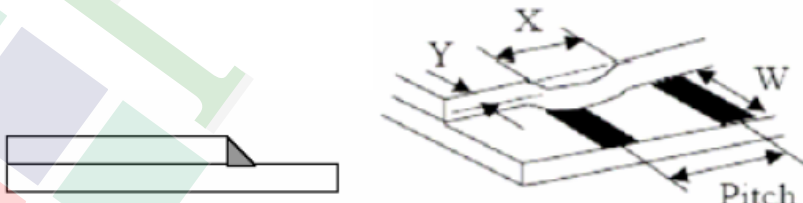
◆ Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level												
08	The crack of glass	<p>Symbols :</p> <p>X : The length of crack Z : The thickness of crack t : The thickness of glass</p> <p>Y : The width of crack. W : terminal length a : LCD side length</p>	Minor												
		<p>8.1.2 Corner crack :</p>  <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td><math>\leq 1/5 a</math></td><td>Crack can't enter viewing area</td><td><math>Z \leq 1/2 t</math></td></tr><tr><td><math>\leq 1/5 a</math></td><td>Crack can't exceed the half of SP width.</td><td><math>1/2 t &lt; Z \leq 2 t</math></td></tr></table>		X	Y	Z	$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$	$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$			
X	Y	Z													
$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$													
$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$													
		<p>8.2 Protrusion over terminal :</p> <p>8.2.1 Chip on electrode pad :</p>  <table><tr><th></th><th>X</th><th>Y</th><th>Z</th></tr><tr><td>Front</td><td><math>\leq a</math></td><td><math>\leq 1/2 W</math></td><td><math>\leq t</math></td></tr><tr><td>Back</td><td><math>\leq a</math></td><td><math>\leq W</math></td><td><math>\leq 1/2 t</math></td></tr></table>		X	Y	Z	Front	$\leq a$	$\leq 1/2 W$	$\leq t$	Back	$\leq a$	$\leq W$	$\leq 1/2 t$	
	X	Y	Z												
Front	$\leq a$	$\leq 1/2 W$	$\leq t$												
Back	$\leq a$	$\leq W$	$\leq 1/2 t$												

**◆ Specification For TFT-LCD Module Less Than 3.5" :**

(Ver.B01)

NO	Item	Criterion	Level												
08	The crack of glass	<p><b>Symbols :</b></p> <div> <div> X : The length of crack  Z : The thickness of crack  t : The thickness of glass </div> <div> Y : The width of crack.  W : terminal length  a : LCD side length </div> </div> <hr/> <p>8.2.2 Non-conductive portion :</p>  <table> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> <tr> <td><math>\leq 1/3 \ a</math></td> <td><math>\leq W</math></td> <td><math>\leq t</math></td> </tr> </table> <p>☉ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>8.2.3 Glass remain :</p>  <table> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> <tr> <td><math>\leq a</math></td> <td><math>\leq 1/3 \ W</math></td> <td><math>\leq t</math></td> </tr> </table>	X	Y	Z	$\leq 1/3 \ a$	$\leq W$	$\leq t$	X	Y	Z	$\leq a$	$\leq 1/3 \ W$	$\leq t$	Minor
		X	Y	Z											
$\leq 1/3 \ a$	$\leq W$	$\leq t$													
X	Y	Z													
$\leq a$	$\leq 1/3 \ W$	$\leq t$													

**◆Specification For TFT-LCD Module Less Than 3.5" :**
**(Ver.B01)**

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
10	General appearance	10. 1 Pin type 、 quantity 、 dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC .	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is $\leq 1.5$ mm.	Minor





## 5. PRECAUTION RELATING PRODUCT HANDLING

### 5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

### 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10$  and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

### 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25 \pm 5$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

### 5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period  
The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility  
This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

**Top View Dimensions:**

- Overall Width: 69.2(OutLine), 67.3(TP Outline)
- TP V.A: 59.5
- TP A.A& LCM V.A: 58.6
- LCD A.A: 57.6
- TP A.A&LCM V.A: 44.2
- LCD A.A: 43.2
- TP V.A: 45.2
- TP A.A&LCM V.A: 48.9
- Overall Height: 50.0(Outline)
- TP V.A: 0.55±0.3
- TP A.A&LCM V.A: (2.9)
- LCD A.A: (3.4)
- TP A.A&LCM V.A: (2.6)
- LCD A.A: (3.1)
- TP V.A: (2.2)
- TP A.A&LCM V.A: 0.4±0.3

**Side View Dimensions:**

- Overall Thickness: 4.25Max (Without Double Tape)
- TP Thickness: 4-0.8
- TP A.A&LCM Thickness: 0.3±0.05

**Detail View Dimensions:**

- TP Thickness: 0.9±0.2
- TP A.A&LCM Thickness: 1.0±0.1
- LCD A.A: 30
- TP A.A&LCM V.A: 46.16±0.1
- TP V.A: 31.0±0.1
- TP A.A&LCM V.A: 44.2
- LCD A.A: 43.2
- TP V.A: 45.2
- TP A.A&LCM V.A: 48.9
- Overall Height: 50.0
- TP V.A: 0.55±0.3
- TP A.A&LCM V.A: (2.9)
- LCD A.A: (3.4)
- TP A.A&LCM V.A: (2.6)
- LCD A.A: (3.1)
- TP V.A: (2.2)
- TP A.A&LCM V.A: 0.4±0.3

**Notes:**

- LCD TYPE: a-Si TFT
- LCD DISPLAY: POSITIVE/TRANSMISSIVE
- VIEWING DIRECTION: 12 O'CLOCK
- THE TOLERANCE UNLESS CLASSIFIED ±0.3mm THE R FOR NOT ASSIGNED 0.5±0.1mm
- DRIVER IC: ILI9341
- A:P1.0X29=29.0±0.05
- COMPONENT AREA HEIGHT 1.0 MAX.
- FPC suggested connector : KYOCERA(00-6200 307 032 800) or compatible.

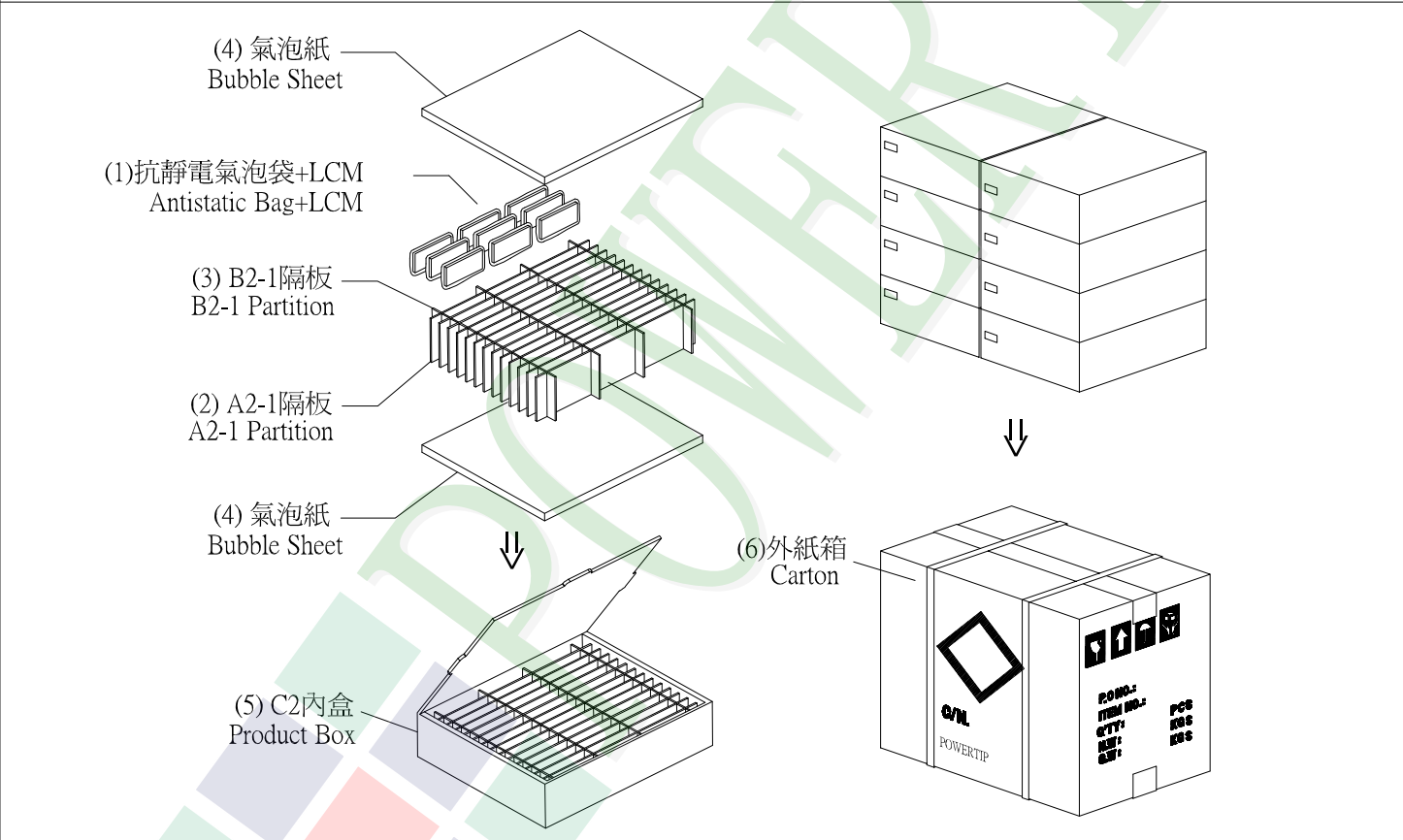
1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH240320T-063-L04Q	69.2 X 50	0.021	288	6.048
2	抗靜電氣泡(1)Bubble Bag	BAG100080BWABA	100 X 80	0.0012	288	0.3456
3	A2-1隔板(2)A2-1 Partition	BX29500072BZBA	295 X 72 X 3.0	0.0109	104	1.1336
4	B2-1隔板(3)B2-1 Partition	BX24500072BZBA	245 X 72 X 3.0	0.0094	32	0.3008
5	氣泡紙(4)Bubble Sheet	BAG280240BWABA	280 X 240	0.006	16	0.096
6	C2內盒(5)Product Box	BX31025580AABA	310 X 255 X 86	0.16	8	1.28
7	外紙箱(6)Carton	BX52732536CCBA	527 X 325 X 360	0.83	1	0.83
8						
9						

2.一 整箱總重量 (Total LCD Weight in carton ) : 10.03 Kg±10%

3.單箱數量規格表 (Packaging Specifications and Quantity) :

(1)Quantity Of Spacer： A2-1隔板 X 13 , B2-2隔板 X 4  
(2)Total LCM quantity in carton : quantity per box 36 x no of boxes 8 = 288



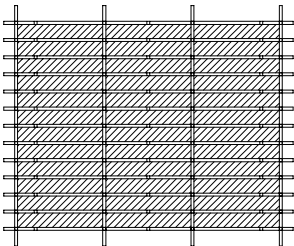
特 記 事 項 (REMARK)

4. Label Specifications :

TYPE			
ID.NO	S/O		
Q'TY	Pcs	Date	
Lot.NO			
Note			

參照"成品包裝點檢作業標準書"內容

5. LCM排放示意圖(前後間隔不放置):  
5. LCM placed as figure showing:  
( First and last slot should be empty)



模組(LCM) X 1 pcs.